

## Application

- $\cdot \, \text{Motor drive}$
- · Inverter, Converter
- $\cdot$  Photovoltaics, wind power generation.
- · Induction heating equipment.

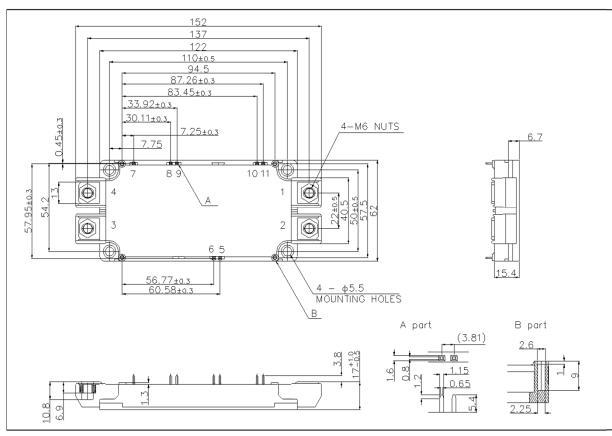
### Features

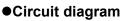
- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

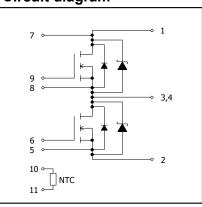
### Construction

This product is a half bridge module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

## •Dimensions & Pin layout (Unit : mm)







Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V <sub>DSS</sub>	G-S short	1200		
Gate-source voltage(+)	V	D-S short	22	v	
Gate-source voltage(-)	V <sub>GSS</sub>		-6	v	
G - S Voltage (t <sub>surge</sub> <300nsec)	V <sub>GSS_surge</sub>	D-S short	-10 to 26		
Drain current *1	I <sub>D</sub>	DC (T <sub>c</sub> =60°C)	300		
	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 1ms * <sup>2</sup>	600	^	
Source current *1	I <sub>S</sub>	DC (T <sub>c</sub> =60°C )	300	A	
	I <sub>SRM</sub>	Pulse (Tc=60°C) 1ms * <sup>2</sup>	600		
Total power disspation *3	Ptot	T <sub>c</sub> =25°C	1875	W	
Max Junction Temperature	T <sub>jmax</sub>		175		
Operating junction temperature	T <sub>jop</sub>		-40 to150	°C	
Storage temperature	T <sub>stg</sub>		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min. 2500		Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	N · m	
Mounting torque	-	Mounting to heat shink : M5 screw	3.5		

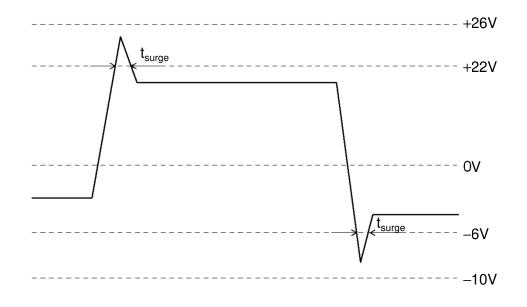
#### •Absolute maximum ratings $(T_j = 25^{\circ}C)$

(\*1) Case temperature  $(T_c)$  is defined on the surface of base plate just under the chips.

(\*2) Repetition rate should be kept within the range where temperature rise if die should not exceed  $T_{j max}$ .

(\*3)  $T_{j}\,$  is less than 175°C

Example of acceptable  $V_{\text{GS}}$  waveform

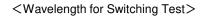


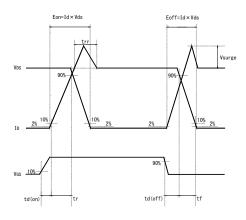
#### •Electrical characteristics (T<sub>i</sub>=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Static drain-source on-state voltage	V <sub>DS(on)</sub>	I <sub>D</sub> =300A, V <sub>GS</sub> =18V	T <sub>j</sub> =25°C	-	2.2	2.9	V
			T <sub>j</sub> =125°C	-	3.0	-	
			T <sub>j</sub> =150°C	-	3.4	4.5	
Drain cutoff current	I <sub>DSS</sub>	V <sub>DS</sub> =1200V, V <sub>GS</sub> =0V		-	-	3.2	mA
Source-drain voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =300A	T <sub>j</sub> =25°C	-	1.6	2.1	V
			T <sub>j</sub> =125°C		2.2	-	
			T <sub>j</sub> =150°C	-	2.4	3.2	
		V <sub>GS</sub> =18V, I <sub>S</sub> =300A	T <sub>j</sub> =25°C	-	1.4	-	
			T <sub>j</sub> =125°C		1.6	-	
			T <sub>j</sub> =150°C	-	1.7	-	
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS}$ =10V, $I_{D}$ =68mA		1.6	2.7	4.0	V
Gate-source leakage current	I <sub>GSS</sub>	$V_{GS}$ =22V, $V_{DS}$ =0V		-	-	0.5	μ <b>A</b>
		$V_{GS}$ = -6V, $V_{DS}$ =0V		-0.5	-	-	
Switching characteristics	t <sub>d(on)</sub>	$\label{eq:VGS(on)} \begin{split} &V_{GS(on)}{=}18V, \ V_{GS(off)}{=}0V \\ &V_{DS}{=}600V \\ &I_{D}{=}300A \\ &R_{G}{=}0.2\Omega \\ &\text{inductive load} \end{split}$		-	80	-	ns
	t <sub>r</sub>			-	70	-	
	t <sub>rr</sub>			-	50	-	
	t <sub>d(off)</sub>			I	250	-	
	t <sub>f</sub>			I	65	-	
Input capacitance	Ciss	$V_{DS}$ =10V, $V_{GS}$ =0V,100kHz		-	32	-	nF
Gate Registance	R <sub>Gint</sub>	T <sub>j</sub> =25°C		-	1.6	-	Ω
NTC Rated Resistance	R25				5.0		kΩ
NTC B Value	B50/25				3370		К
Stray Inductance	Ls				13	-	nH
Creepage Distance	-	Terminal to heat sink			14.5	-	mm
		Terminal to terminal			15.0	-	mm
Clearance Distance	-	Terminal to heat sink			12.0	-	mm
		Terminal to terminal			9.0	-	mm
Junction-to-case thermal	ction-to-case thermal R <sub>th</sub> (j-c)		DMOS (1/2 module) *4		-	0.08	
resistance	ι ι <sub>th</sub> (j-υ)	SBD (1/2 module) *4		-	-	0.11	K/W
Case-to-heat sink	R <sub>th</sub> (c-f)	Case to heat sink, per 1 module, Thermal grease applied * <sup>5</sup>		-	0.035	-	
Thermal resistance	ι ι <sub>th</sub> (υ-1)						

(\*4) Measurement of Tc is to be done at the point just under the chip.

- (\*5) Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m · K).
- (\*6) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.





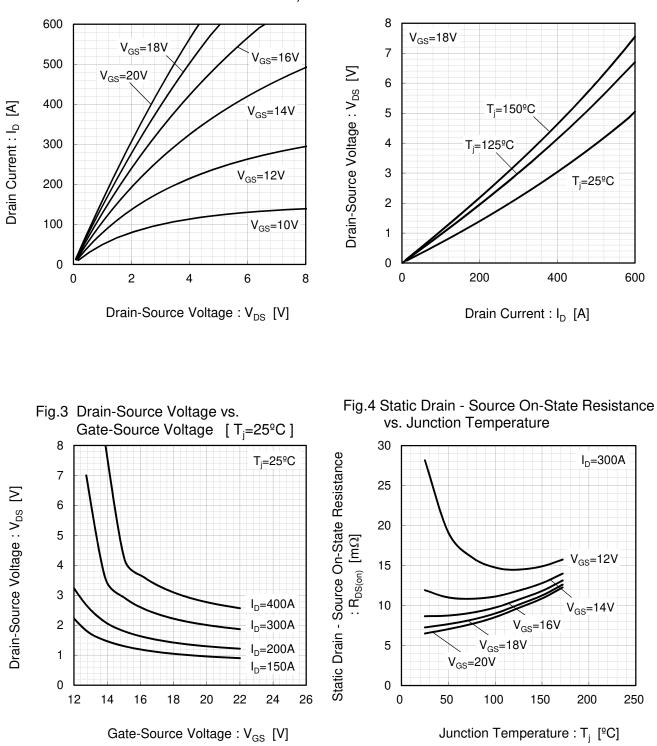


Fig.1 Typical Output Characteristics [ $T_j=25^{\circ}C$ ] Fig.2 Drain-Source Voltage vs. Drain Current

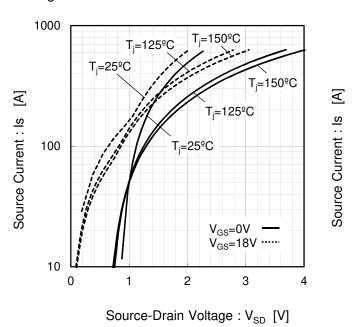
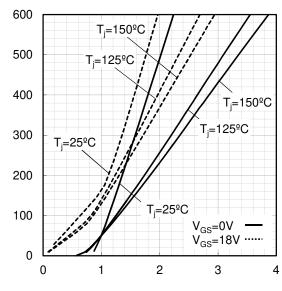
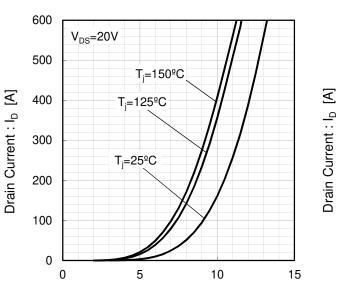


Fig.5 Forward characteristic of Diode Fig.6 Forward characteristic of Diode



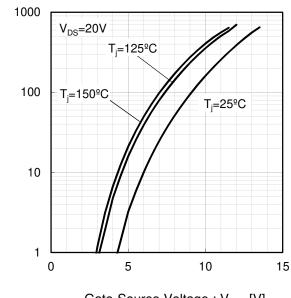
Source-Drain Voltage :  $V_{SD}$  [V]

#### Fig.7 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V<sub>GS</sub> [V]

#### Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage :  $V_{GS}$  [V]

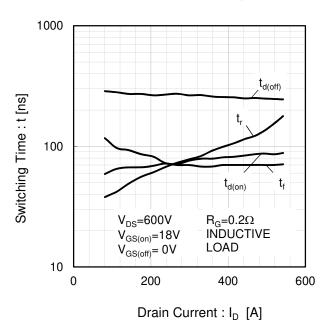
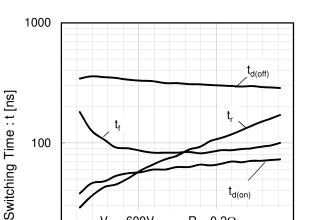


Fig.9 Switching Characteristics [T<sub>i</sub>=25<sup>o</sup>C]



t<sub>d(on)</sub>

600

 $R_{G}$ =0.2 $\Omega$ INDUCTIVE

400

LOAD

Drain Current : I<sub>D</sub> [A]

t

V<sub>DS</sub>=600V

V<sub>GS(on)</sub>=18V

 $V_{GS(off)} = 0V$ 

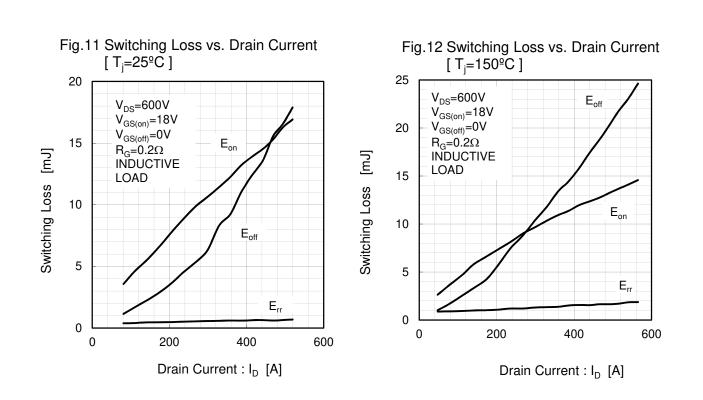
200

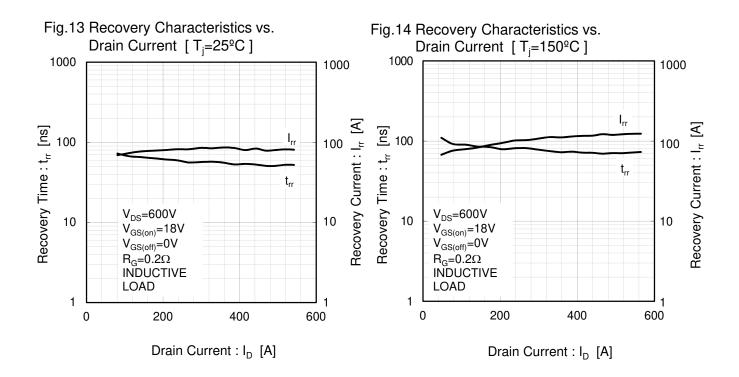
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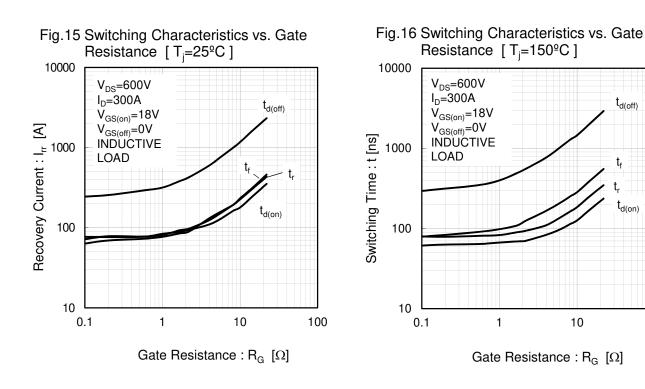
10

0

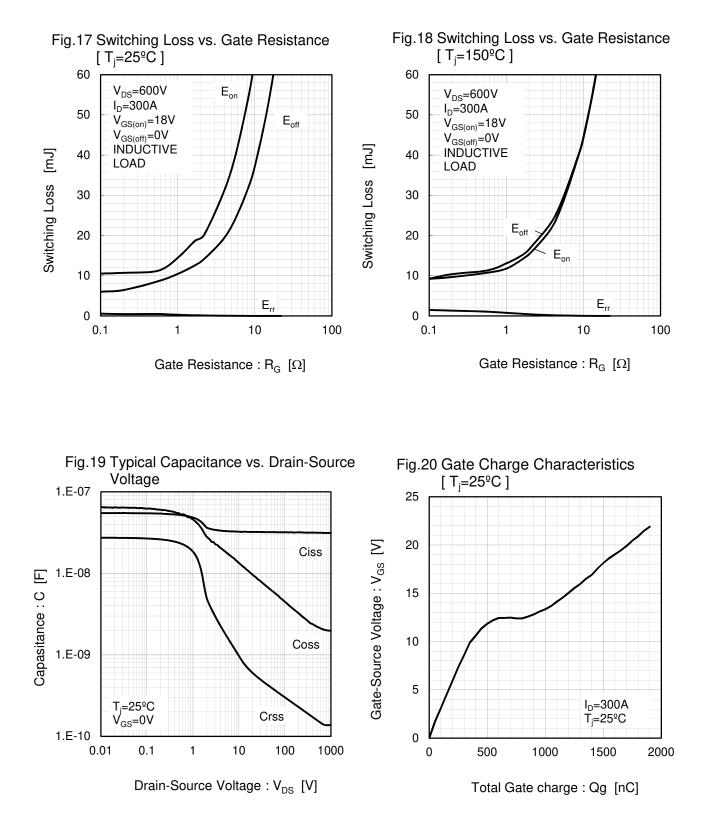
Fig.10 Switching Characteristics [ $T_i=150^{\circ}C$ ]

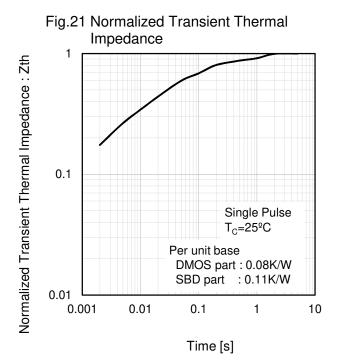






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